

- 1. Open the earlier project that we created called WalkthroughCSVImport
- 2. Select File>Save As and give the new project the name SaggingConductor
- 3. Once returned to the main form select the **Profiles** option from the top toolbar menu. A new window will open



- 4. Make sure under **Visuals>Point No.'s** is turned on. You should then be able to see the aerial points between Poles 1 & 2 that have been collected during the survey marked as point no.'s "179" & "180".
- 5. We are now going to sag Circuit 1 through the aerial point no. "179"
- 6. Select the option Sag. The following window will open



.....



## **COLDNet Profile – Sagging Conductor**

- 7. There are two options available to select the aerial points for sagging the conductor, either Select Single Point or Select by Window. For this example we are going to Select Single Point by left mouse-clicking on point no. "179" on the elevation view. The point will then appear in the table of our open window. Aerial points can be removed by selecting Delete Current Row
- 8. Next, select the circuit and conductor to sag through the selected aerial points. Select "Level 1 : Libra x3"
- 9. Enter a Conductor Temperature for Sagging of "30"
- 10. Select Calculate Tension. This will generate a new Stringing value and a new Tension as seen below

Sag Conductor						
O Select Single Point    ● Select by Window						
	Select points for sagging from the profile window					
	Point No.	Chainage (m)	Height (m)	Feature Description	Calculated Stringing (%CBL)	Pole on Left of Span
	179	19.798	8.650	Aerial	2.6	0
	Delete Current Row					
	Level 1 : Libra x3					
	Level 2 : SC/AC 3/2.75 x4					
	Conductor temperature for sagging (°C) : 30					
	Result			Calculate Tension		
	Research		Stringin	g (%CBL) :	2.6	
			Tension	(N) :	207.7	
		pt Result & Upr	date Everyd		Clear	Close

11. If you're happy with the new results and want to update your design select **Accept Results & Update Everyday Stringing**. The design will have updated in the background. Select **Close** to see the new sagging of the conductor for Circuit 1. This process can be repeated for each of the attachments on the circuits.

